



SPE0522

2-Line ESD Protection Array

DESCRIPTION

The SPE0522 are designed by TVS bi-direction device that is to protect sensitive electronics from damage or latch-up due to ESD. They are designed for use in applications where board space is at a premium. SPE0522 will protect up to two lines, and may be used on lines where the signal polarities swing above and below ground.

SPE0522 offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

SPE0522 may be used to meet the immunity requirements of IEC 61000-4-2, level 4. The small SOT-523 package makes them ideal for use in portable electronics such as cell phones, PDA's, notebook computers, and digital cameras.

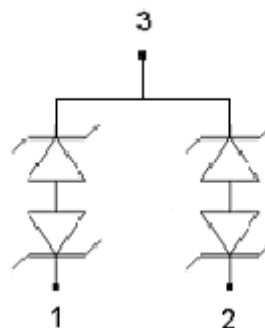
APPLICATIONS

- ◆ Cellular Handsets and Accessories
- ◆ Cordless Phone
- ◆ PDA
- ◆ Notebooks and Handhelds
- ◆ Portable Instrumentation
- ◆ Digital Cameras
- ◆ MP3 Player

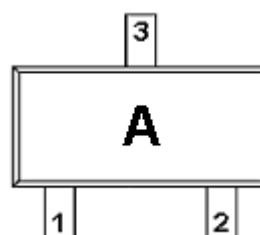
FEATURES

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 8\text{kV}$ (contact)
- ◆ IEC 61000-4-4 (EFT) 40A (5/50ns)
- ◆ Protects two I/O lines
- ◆ Working voltage: 5V
- ◆ Low leakage current
- ◆ Low operating and clamping voltages

PIN CONFIGURATION (SOT-523 / SC-89)



PART MARKING





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ORDERING INFORMATION

Part Number	Package	Part Marking
SPE0522S52RG	SOT-523	A
SPE0522S52RGB	SOT-523	A

- ※ SPE0522S52RG : Tape Reel ; Pb – Free
※ SPE0522S52RGB : Tape Reel ; Pb – Free ; Halogen -Free

ABSOLUTE MAXIMUM RATINGS

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Peak Pulse Power (t _p = 8/20 μs)	P _{pk}	250	W
Maximum Peak Pulse Current (t _p = 8/20 μs)	I _{pp}	7	A
ESD per IEC 61000 – 4 – 2 (Air)	V _{pp}	±15	KV
ESD per IEC 61000 – 4 – 2 (Contact)	V _{pp}	±8	KV
Operating Junction Temperature	T _J	-55 ~ 125	°C
Storage Temperature Range	T _{STG}	-55 ~ 150	°C
Lead Soldering Temperature	T _L	260 (10sec)	°C

ELECTRICAL CHARACTERISTICS

(T_A=25°C Unless otherwise noted)

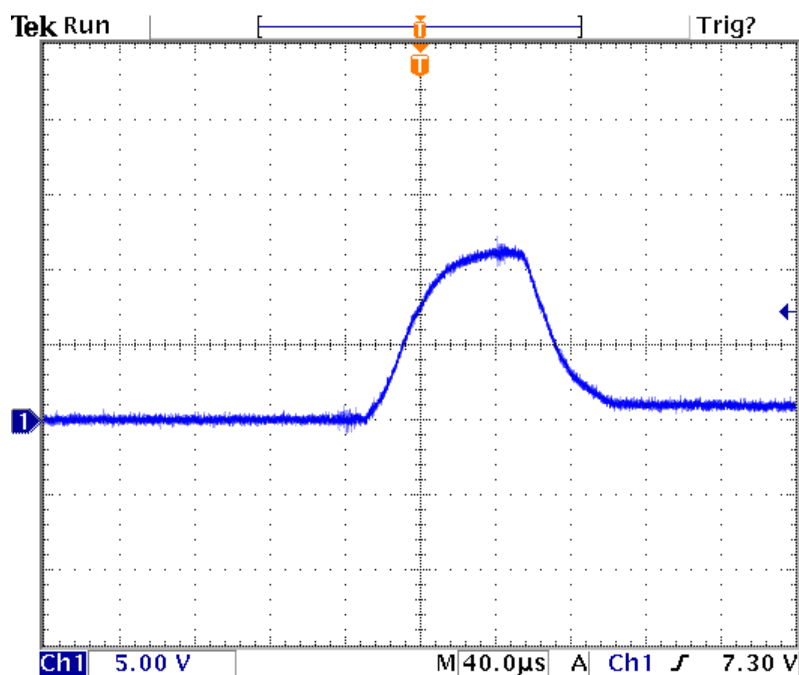
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Reverse Stand – Off Voltage	V _{RWM}				5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA	6			V
Reverse Leakage Current	I _R	V _{RWM} = 5V , T=25°C		0.01	1	μA
Reverse Leakage Current	I _R	V _{RWM} = 3V , T=25°C		0.01	0.5	μA
Clamping Voltage	V _C	I _{pp} = 1A , t _p = 8/20 μs			13	V
Clamping Voltage	V _C	I _{pp} = 7A , t _p = 8/20 μs			17	V
Junction Capacitance	C _j	Between I/O Pin and GND V _R = 0V , f = 1MHz		5	10	pF



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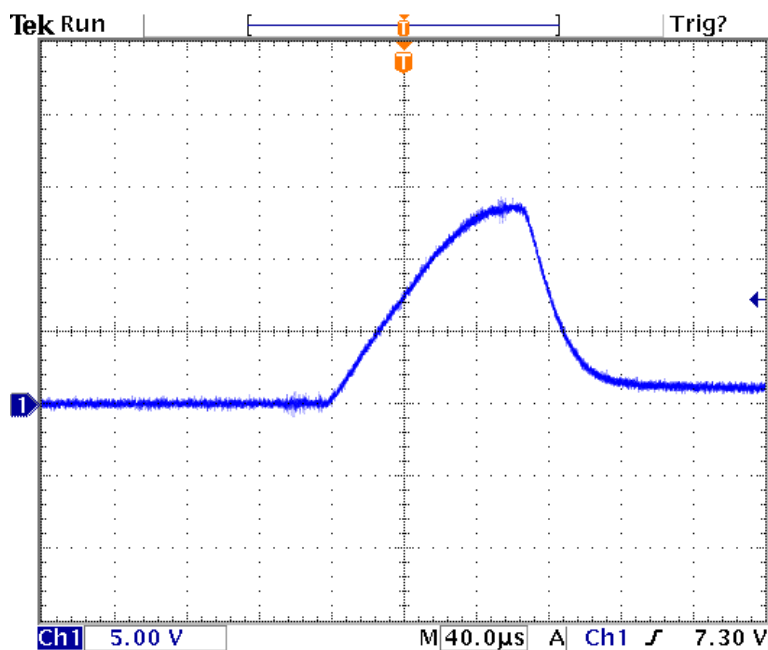
TYPICAL CHARACTERISTICS



40.0000ns

Clamping Voltage ($I_{pp} = 1A$, $t_p = 8/20 \mu s$)

26 Oct 2005
12:15:46



40.0000ns

Clamping Voltage ($I_{pp} = 7A$, $t_p = 8/20 \mu s$)

26 Oct 2005
12:08:20



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TYPICAL CHARACTERISTICS

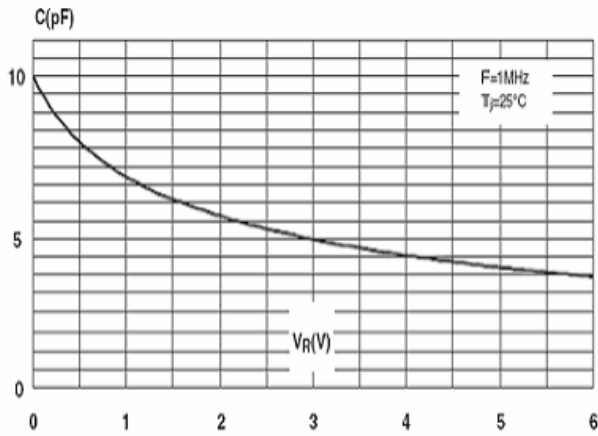


Fig 1 : Junction Capacitance V.S Reverse Voltage Applied

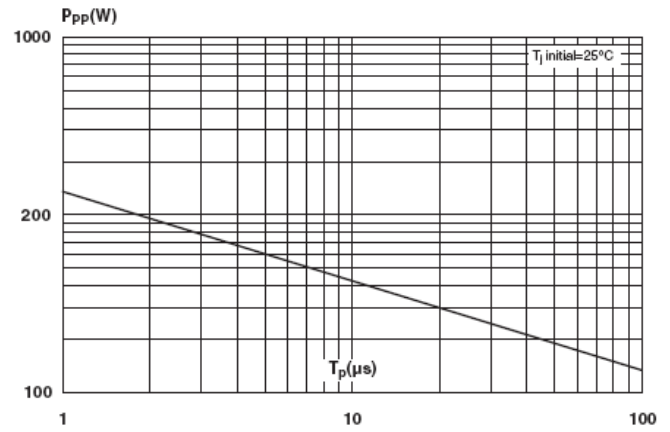


Fig 2 : Peak Plus Power V.S Exponential Plus Duration

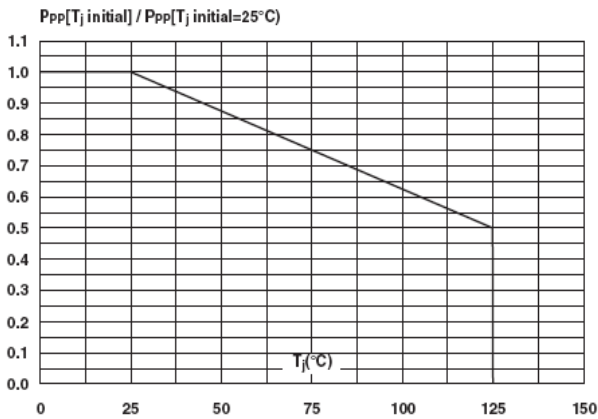


Fig 3 : Relative Variation of Peak Plus Power V.S Initial Junction Temperature

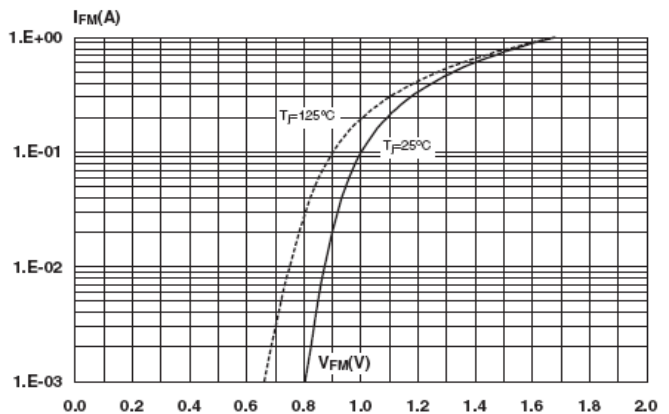


Fig 4 : Forward Voltage Drop V.S Peak Forward Current



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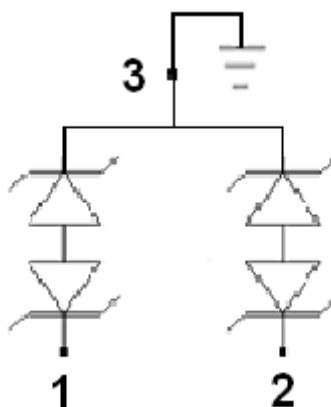
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APPLICATION NOTE

Device Connection for Protection of Two Data Lines

SPE0522 is designed to protect up to two data lines. The bidirection device is connected as follows:

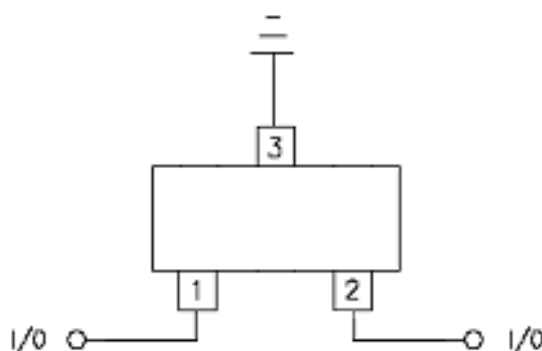
1. The TVS protection of two I/O lines is achieved by connecting pins 1 and 2 to the data lines. Pin 3 is connected to ground. The ground connection should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance.



Circuit Board Layout Recommendations for Suppression of ESD

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

1. Place the TVS near the input terminals or connectors to restrict transient coupling.
2. Minimize the path length between the TVS and the protected line.
3. Minimize all conductive loops including power and ground loops.
4. The ESD transient return path to ground should be kept as short as possible.
5. Never run critical signals near board edges.
6. Use ground planes whenever possible.

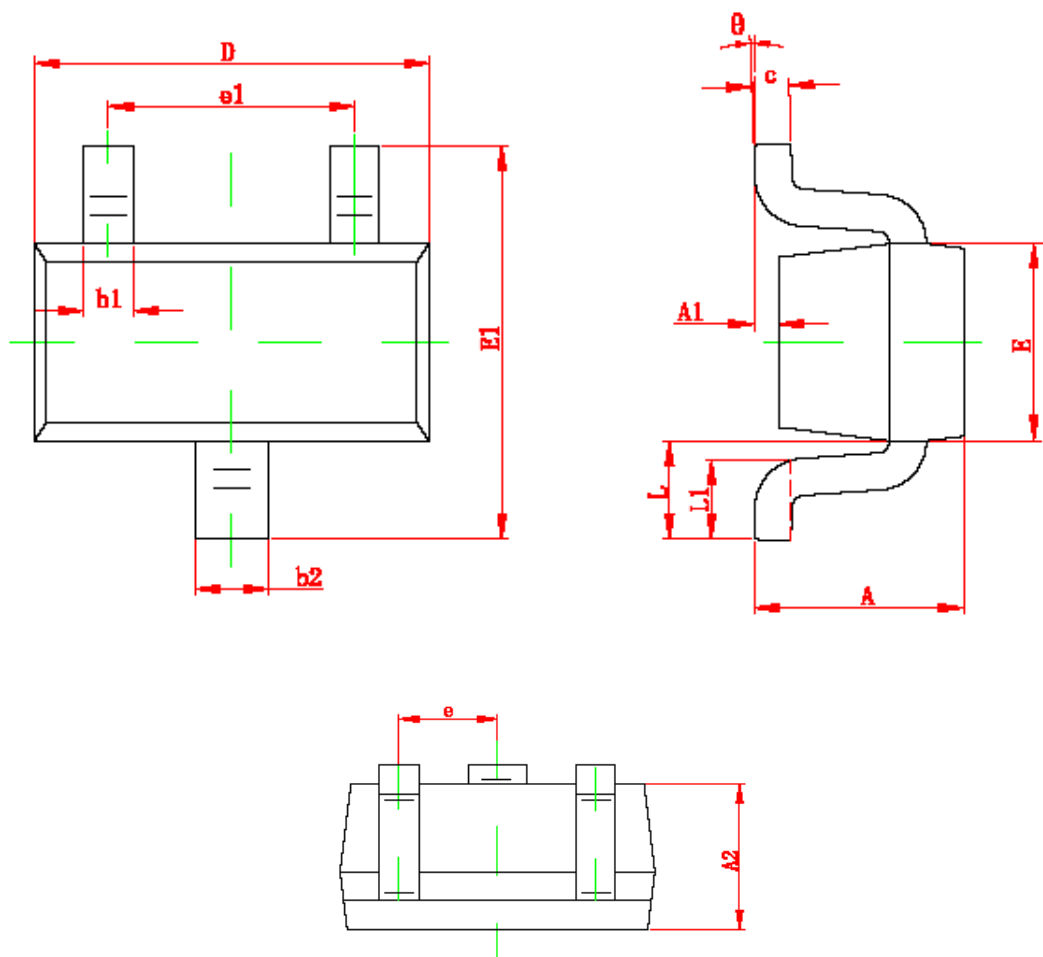




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SOT-523 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
theta	0°	8°	0°	8°



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